

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Kouji HAGA et al.**

Serial No.: **Not yet assigned**
(§371 of international application No. PCT/JP2003/10001)

Filed: **February 8, 2005**

For: **POLISHING SLURRY FOR CHEMICAL
MECHANICAL POLISHING AND METHOD FOR
POLISHING SUBSTRATE**

Attorney Docket No.: **052107**
Customer Number: **38834**

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

February 8, 2005

Sir:

Prior to calculation of the filing fee and examination of this application, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Remarks begin on page 4 of this paper.